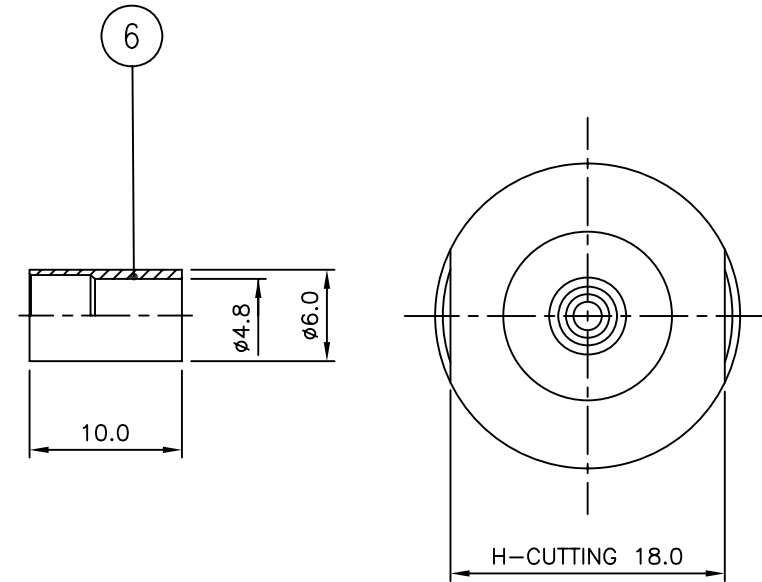
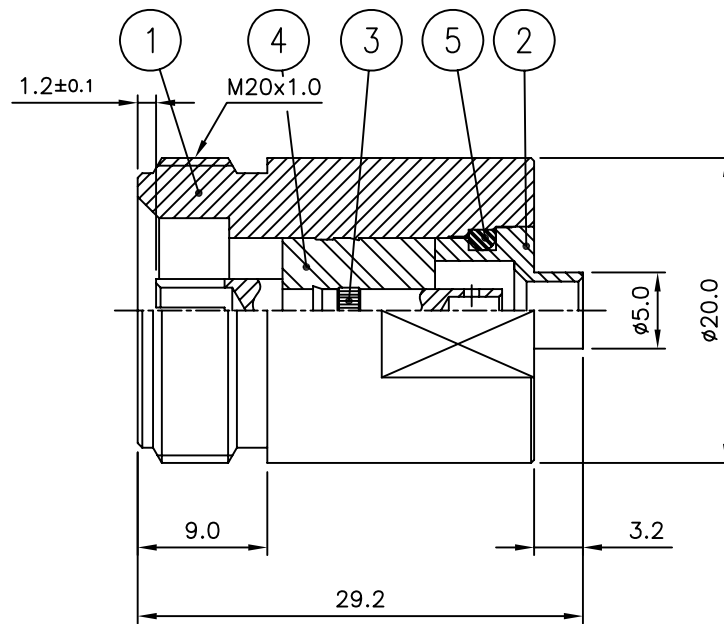


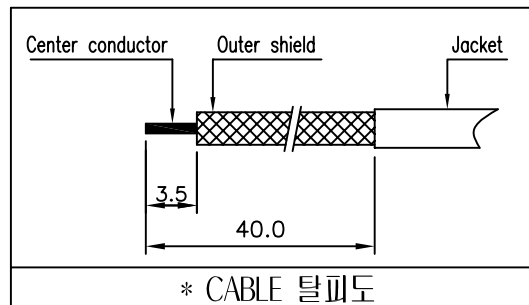
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	H.J.LEE	I.C.KIM	2016.01.18.



*PIN+TEFLON 완제품 조립 X

*CABLE+PIN 조립 방법

1. ②번+⑤번 조립 후 ①번 BODY에 억지끼움을 한다.
2. ③번+④번 조립을 한다.
3. CABLE 을 납땜부로 밀어 넣는다.
4. ③번에 CABLE을 땀 한다.
5. CEQ00382-N/1 조립 JIG를 사용하여 ③번+④번을 조립한다.



6	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DFE00163-5/1
5	GASKET	1	SILICONE RUB		DGK00026-N/1
4	INSULATOR	1	TEFLON		DIN02662-N/1
3	CONTACT	1	BeCu C17300	Silver Plate (5μm)	DCT03568-5/2
2	BODY(B)	1	MBsBD C3604BD-F	SUCO Plate	DBD04035-5/1
1	BODY(A)	1	MBsBD C3604BD-F	SUCO Plate	DBD04034-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2016. 01. 18.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE 4.1/9.5DIN50 CABLE JS 141FJ
		DRAWN BY	H.J.LEE	
FINISH		SCALE	2/1	DWG NO. CN03494-7/2 REVISION I R SHEET 1 of 1
		UNIT	mm	